

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
(Not for submission under 37 CFR 1.99)

Application Number		
Filing Date		
First Named Inventor	Hiroki WAKAMATSU	
Art Unit		
Examiner Name		
Attorney Docket Number	36856.1438	

U.S.PATENTS

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	1	20040079791		2004-04-29	Kida et al.	

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FOREIGN PATENT DOCUMENTS

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	1	2003-178844	JP	A	2003-06-27			<input checked="" type="checkbox"/>
	2	2004-047827	JP	A	2004-02-12			<input checked="" type="checkbox"/>

Receipt date: 05/05/2006

10595698 - GAU: 2833

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3	04-162460	JP	A	1992-06-05			<input checked="" type="checkbox"/>
4	09-172124	JP	A	1997-06-30			<input checked="" type="checkbox"/>
5	3096377	JP	U	2003-06-25			<input checked="" type="checkbox"/>
6	2001-176612	JP	A	2001-06-29			<input checked="" type="checkbox"/>
7	08-213070	JP	A	1996-08-20			<input checked="" type="checkbox"/>
8	10-247535	JP	A	1998-09-14			<input checked="" type="checkbox"/>
9	2002-203627	JP	A	2002-07-19			<input checked="" type="checkbox"/>
10	2000-313992	JP	A	2000-11-14			<input checked="" type="checkbox"/>
11	2000-313986	JP	A	2000-11-14			<input checked="" type="checkbox"/>
12	62-199795	JP	A	1987-09-03			<input checked="" type="checkbox"/>
13	62-199794	JP	A	1987-09-03			<input checked="" type="checkbox"/>

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	14	09-330629	JP	A	1997-12-22			<input checked="" type="checkbox"/>
	15	10-084065	JP	A	1998-03-31			<input checked="" type="checkbox"/>
	16	2000-087293	JP	A	2000-03-28			<input checked="" type="checkbox"/>

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NON-PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.	T ⁵
	1	YAMAMOTO et al.; "Reactivity to Form Intermetallic Compounds in the Micro Joint Using Sn-Ag Solder"; MES2003; 10/2003; pp. 45-48.	<input checked="" type="checkbox"/>
	2	KOBAYASHI et al.; "Rapid Alloying in the Micro Joints Between Sn-Ag Solder and Au/Ni-Co Plating"; MES2004; 10/2004; pp. 233-236.	<input checked="" type="checkbox"/>
	3	International Search Report issued in the corresponding International Application No. PCT/JP2005/021817, mailed on December 12, 2005.	<input checked="" type="checkbox"/>

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